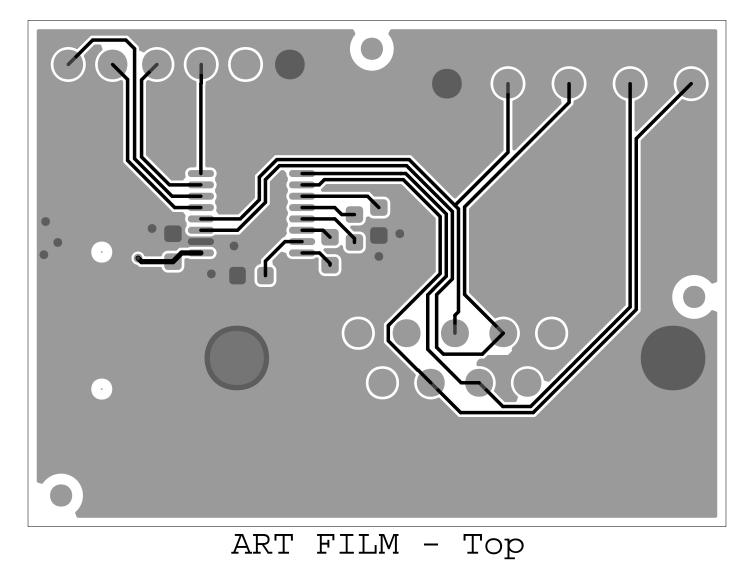
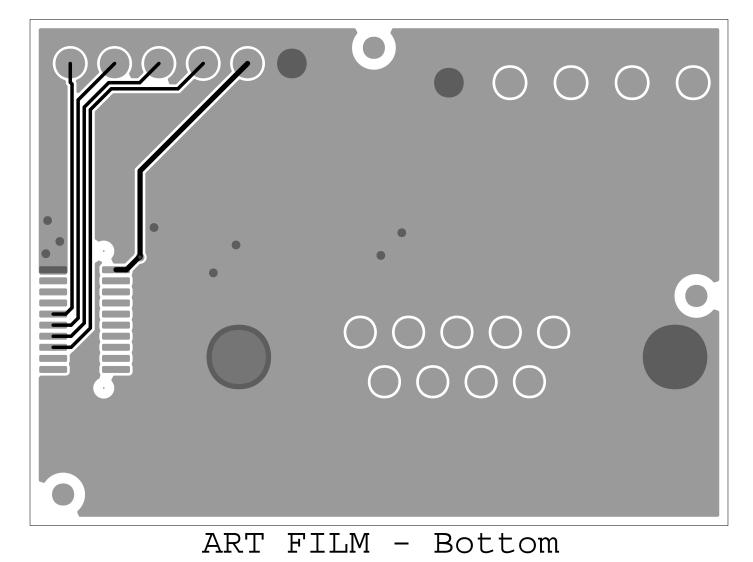
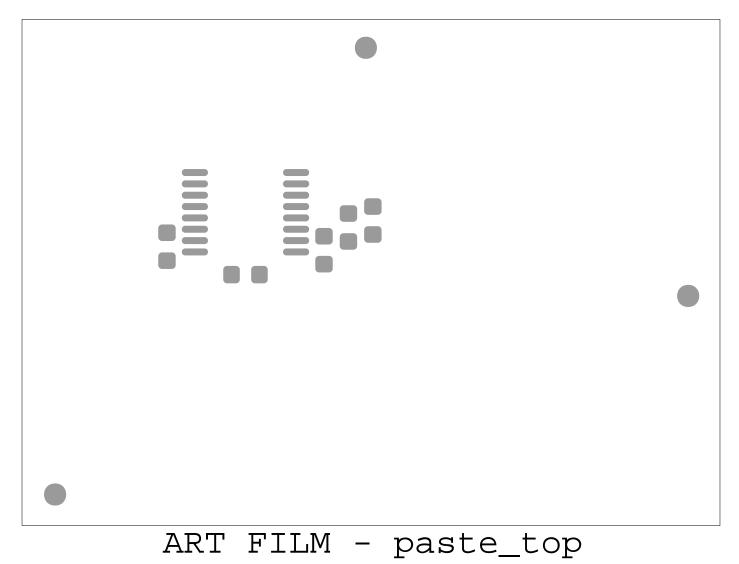
ART FILM - Top



ART FILM - Bottom

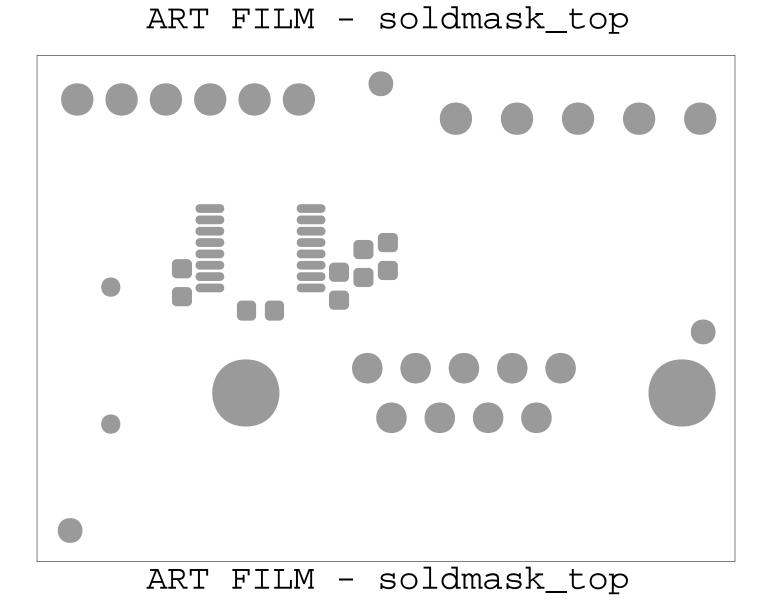


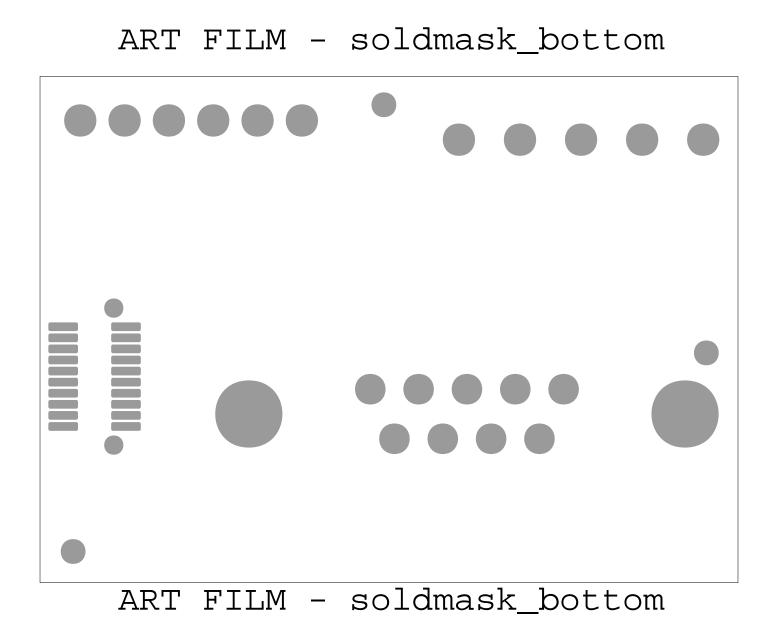
ART FILM - paste_top



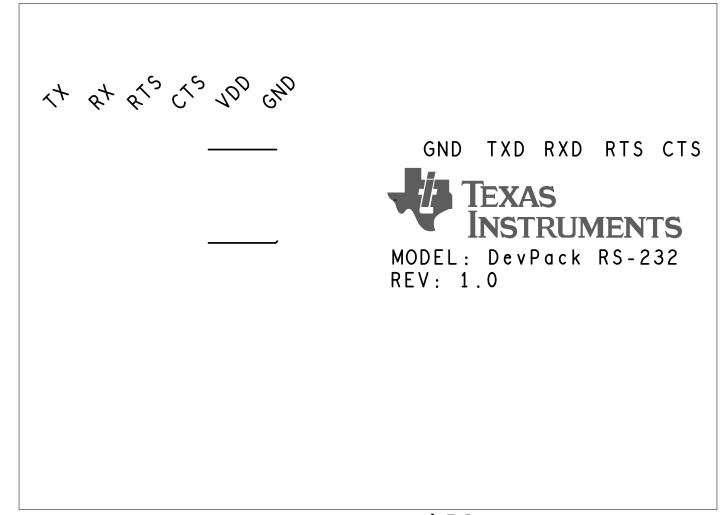
ART FILM - paste_bottom







ART FILM - silk_top



ART FILM - silk_top

ART FILM - silk_bottom



ART FILM - silk_bottom

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